L Number	Hite	Search Text	DB	Time stamp
1	47	epcos.as. and piezoelectric	USPAT;	2003/09/08 07:31
1	] ''	epeos.us. una prozocretaria	US-PGPUB;	
			EPO; JPO;	
			DERWENT;	
			IBM TDB	
i	131272	piezoelectric .	USPAT;	2002/06/07 16:30
-	1312/2	piezoeiecciic	US-PGPUB;	
			EPO; JPO;	
			DERWENT;	1
			IBM TDB	
	0175	piezoelectric and polyurethane	USPAT;	2002/06/07 16:51
-	2175	prezoerectic and porydrechane	US-PGPUB;	2002,00,00
	1		EPO; JPO;	
			DERWENT;	
			IBM TDB	
	050	(-il-the and maleurothana) and	USPAT;	2002/06/03 12:05
-	250	(piezoelectric and polyurethane) and	US-PGPUB;	2002/00/03 12:03
		ceramic and copper		
			EPO; JPO;	
1			DERWENT;	
			IBM_TDB	2002/06/02 10:10
-	165	((piezoelectric and polyurethane) and	USPAT;	2002/06/03 10:18
		ceramic and copper) and electrode	US-PGPUB;	
			EPO; JPO;	
1	1		DERWENT;	
			IBM_TDB	
-	9		USPAT;	2002/06/03 10:34
1		ceramic and copper) and electrode) and	US-PGPUB;	
		perovskite	EPO; JPO;	
			DERWENT;	
			IBM_TDB	
_	9	(("5536449") or ("5661094") or	USPAT;	2002/06/03 10:35
		("4819128")).PN.	US-PGPUB;	
			EPO; JPO;	
			DERWENT;	
			IBM TDB	
_	1 0	(piezoelectric and polyurethane) and	USPAT;	2002/06/03 12:06
		ceramic and copper and peroskite	US-PGPUB;	
			EPO; JPO;	
			DERWENT;	
1			IBM TDB	
_	12	(piezoelectric and polyurethane) and	USPAT;	2003/09/08 06:23
		ceramic and copper and perovskite	US-PGPUB;	
		Columns and sopport and present	EPO; JPO;	
			DERWENT;	
			IBM TDB	1
1_	17644	piezoelectric with ceramic	USPĀT;	2002/06/03 12:08
	1,044	Proposition with our many	US-PGPUB;	
			EPO; JPO;	
			DERWENT;	
			IBM TDB	
	1195	(piezoelectric with ceramic) -and-copper	USPAT;	2002/06/03 12:08
	TT32	(bresperenting when defaute) and copper	US-PGPUB;	
			EPO; JPO;	
			DERWENT;	
			IBM TDB	
	151	(/min-polestric with commis) and commen	USPAT;	2002/06/03 12:08
-	151	((piezoelectric with ceramic) and copper)	US-PGPUB;	2002,00,00 12.00
		and binder	EPO; JPO;	
			DERWENT;	
	1			]
		/	IBM_TDB USPAT;	2002/06/03 12:08
-	843	(piezoelectric with ceramic) and binder	US-PGPUB;	2002,00,00 12.00
			i e	
			EPO; JPO;	
			DERWENT;	
	_		IBM_TDB	2002/06/03 12:08
<del>-</del>	180	1 ' '*	USPAT;	2002/00/03 12:08
		and grain	US-PGPUB;	
	[		EPO; JPO;	
			DERWENT;	]
1	1		IBM TDB	

<u> </u>	112	((piezoelectric with ceramic) and binder)	USPAT;	2002/06/03 12:08
		and perovskite	US-PGPUB;	
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	
ĺ _	87	(((piezoelectric with ceramic) and binder)	USPAT;	2003/02/03 11:56
		and perovskite) and electrode	US-PGPUB;	
		-	EPO; JPO;	1
			DERWENT;	
	•		IBM_TDB	
l <b>-</b>	3	("5233260").PN.	USPAT;	2002/06/07 16:30
			US-PGPUB;	
			EPO; JPO;	
			DERWENT;	
			IBM TDB	1
1_	1	"2633543".PN.	USPĀT	2002/06/07 16:30
	1	"3635016".PN.	USPAT	2002/06/07 16:30
l_	1	"4472652".PN.	USPAT	2002/06/07 16:30
i	ī	"4845399".PN.	USPAT	2002/06/07 16:31
_	1	"4803763".PN.	USPAT	2002/06/07 16:35
_	114	perovskite and polyurethane	USPAT;	2002/06/07 16:50
-	114	boro.ouree con borleseemen	US-PGPUB;	
			EPO; JPO;	1
			DERWENT;	
			IBM TDB	
1	248119	polyurethane	USPAT;	2002/06/07 16:50
-	248119	polyurechane	US-PGPUB;	2002, 00, 0
			EPO; JPO;	
			DERWENT;	
			IBM TDB	
	0107		USPAT;	2002/06/07 16:50
-	2187	polyurethane and piezoelectric	US-PGPUB;	2002/00/07 10:00
1			EPO; JPO;	
			DERWENT;	]
			IBM TDB	
			USPAT;	2002/06/11 09:21
-	131601	piezoelectric	US-PGPUB;	2002/00/11 03:21
	1		EPO; JPO;	
		·	DERWENT;	
			IBM TDB	
			USPAT;	2002/06/07 16:51
-	2187	piezoelectric and polyurethane	US-PGPUB;	2002/00/07 10.31
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	2002/06/07 16:52
-	859	(piezoelectric and polyurethane) and	USPAT;	2002/06/07 16:52
		ceramic	US-PGPUB;	
	1		EPO; JPO;	
			DERWENT;	
			IBM_TDB	2002/06/07 16:52
-	250		USPAT;	
		ceramic) and copper	US-PGPUB;-	
			EPO; JPO;	
1	1		DERWENT;	
	1		IBM_TDB	1 0000 /05 /05 15 50
-	85		USPAT;	2002/06/07 16:52
		ceramic) and copper) and binder	US-PGPUB;	
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	
1 -	7		USPĀT;	2002/06/07 16:53
	1	ceramic) and copper) and binder) and	US-PGPUB;	
	1	perovskite	EPO; JPO;	
		<b> </b>	DERWENT;	
			IBM_TDB	
l _	1	"4917810".PN.	USPAT	2002/06/07 16:53
_	l i		USPAT	2002/06/07 16:53
_	1		USPAT	2002/06/07 16:54
_	1		USPAT	2002/06/07 16:55
L	<u> </u>	000000 1200		

-	131695	piezoelectric	USPAT;	2002/06/11 09:21
			US-PGPUB;	
			EPO; JPO;	
			DERWENT;	
			t .	
			IBM_TDB	
-	29560	piezoelectric and layer	USPAT;	2002/06/11 09:22
			US-PGPUB;	
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	<b></b>
-	31045	piezoelectric and (layer or laminate)	USPAT;	2002/06/11 09:24
			US-PGPUB;	
			EPO; JPO;	
			DERWENT;	
			,	
			IBM_TDB	
-	1582	(piezoelectric and (layer or laminate))	USPAT;	2002/06/11 09:24
		and binder	US-PGPUB;	
			EPO; JPO;	
			DERWENT;	
	}			
			IBM_TDB	
-	485	((piezoelectric and (layer or laminate))	USPAT;	2002/06/11 09:25
1		and binder) and copper	US-PGPUB;	I
1			EPO; JPO;	I
1			DERWENT;	I
1				1
1			IBM_TDB	1
-	296	(((piezoelectric and (layer or laminate))	USPĀT;	2002/06/11 09:25
		and binder) and copper) and electrode	US-PGPUB;	
		and pinder, and copper, and credered	EPO; JPO;	
			DERWENT;	
			IBM_TDB	l
l _	36	((((piezoelectric and (layer or	USPAT;	2002/06/11 09:56
		laminate)) and binder) and copper) and	US-PGPUB;	
		electrode) and perovskite	EPO; JPO;	
			DERWENT;	İ
	1		IBM TDB	
_	1	"5335139".PN.	USPĀT	2002/06/11 09:29
	1	"5561587".PN.	USPAT	2002/06/11 09:30
l .	1			2002/06/11 09:31
ļ -	1	"5668694".PN.	USPAT	
-	1	"5862034".PN.	USPAT	2002/06/11 09:32
-	1	"5877934".PN.	USPAT	2002/06/11 09:32
-	1	"6124769".PN.	USPAT	2002/06/11 09:32
<b>!</b> _	1	"6160472".PN.	USPAT	2002/06/11 09:45
-	1		USPAT	2002/06/11 09:47
-	1	"6185087".PN.		
1-	1	("6360393").PN.	USPAT;	2002/06/11 09:57
			US-PGPUB;	
1			EPO; JPO;	
			DERWENT;	1
1			IBM TDB	
1				0000/06/11 11:10
-	1	("6360693").PN.	USPAT;	2002/06/11 11:13
			US-PGPUB;	
			EPO; JPO;	
			DERWENT; -	
				1
		l	IBM_TDB	0000/06/11 11 17
-	35478	polyurethane and binder	USPAT;	2002/06/11 11:15
1			US-PGPUB;	
			EPO; JPO;	
1			DERWENT;	
			1	
			IBM_TDB	
-	5252	(polyurethane and binder) and ceramic	USPAT;	2002/06/11 14:18
			US-PGPUB;	
1			EPO; JPO;	
1			1	
			DERWENT;	
			IBM_TDB	
-	1023	((polyurethane and binder) and ceramic)	USPAT;	2002/06/11 11:15
		and electrode	US-PGPUB;	
1			EPO; JPO;	
			1	
			DERWENT;	
I			IBM TDB	l

2211	((polyurethane and binder) and ceramic) and copper	USPAT; US-PGPUB;	2002/06/11 11:15
		DERWENT;	
602	(((polyurethane and binder) and ceramic) and electrode) and copper	USPĀT; US-PGPUB;	2002/06/11 11:16
		EPO; JPO; DERWENT;	
197		USPAT; US-PGPUB;	2002/06/11 11:17
	laminate) and green	EPO; JPO; DERWENT;	
34		USPĀT;	2002/06/11 11:17
	laminate) and green) and piezoelectric	EPO; JPO; DERWENT;	
1440	(polyurethane and binder) and ceramic and	USPĀT;	2002/06/11 14:22
	green	EPO; JPO; DERWENT;	
20	1 ' 12 3	USPĀT;	2002/06/11 14:22
	green, and perovokite	EPO; JPO; DERWENT;	
1440	(polyurethane and binder) and ceramic and	USPĀT;	2002/06/11 14:22
	y con	EPO; JPO; DERWENT;	
42	(polyurethane and binder) and ceramic and	USOCR	2002/06/11 14:27
23	((polyurethane and binder) and ceramic and	USOCR	2002/06/11 14:28
116		USPAT; US-PGPUB;	2003/02/03 12:34
		DERWENT;	
45	and perovskite) and electrode and (copper	USPĀT; US-PGPUB;	2003/02/03 13:17
	"Cu")	DERWENT;	
409	epcos.as.	USPĀT; US-PGPUB;	2003/02/03 13:17
- ()		DERWENT;	
34	epcos.as. and piezoelectric	USPAT; US-PGPUB;	2003/09/08 07:31
		EPO; JPO; DERWENT;	
14	(piezoelectric and polyurethane) and ceramic and copper and perovskite	USPAT; US-PGPUB;	2003/09/08 06:23
	Total and party	EPO; JPO; DERWENT;	
	602 197 34 1440 20 1440 42 23 116 45	and copper  ((((polyurethane and binder) and ceramic) and electrode) and copper  (((((polyurethane and binder) and ceramic) and electrode) and copper) and (layer or laminate) and green  ((((((polyurethane and binder) and ceramic) and electrode) and copper) and (layer or laminate) and green) and piezoelectric  (polyurethane and binder) and ceramic and green  ((polyurethane and binder) and ceramic and green) and perovskite  (polyurethane and binder) and ceramic and green  ((polyurethane and binder) and ceramic and green  ((polyurethane and binder) and ceramic and green) and copper  (((piezoelectric with ceramic) and binder) and perovskite) and electrode  (((piezoelectric with ceramic) and binder) and perovskite) and electrode and (copper "Cu")  (popos.as. and piezoelectric	and copper    SP-EGUB;   CPC; JPC; DERWENT; IBM TDB   USPAT; USP-EGUB; EPC; JPC; JPC; JPC; JPC; JPC; JPC; JPC; J